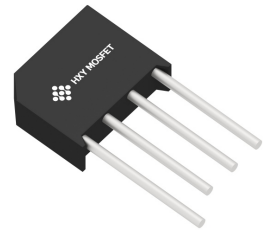


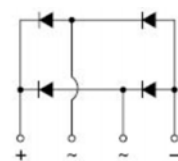


## Features

- This series is UL listed under the Recognized Component Index, file number E142814
- Ideal for printed circuit board mounting
- The plastic material used carries Underwriters Laboratory flammability recognition 94V-0
- Built-in printed circuit board stand-offs
- High case dielectric strength
- High temperature soldering guaranteed 265 °C/10 seconds at 5 lbs (2.3kg) tension



KBL



## Ordering Information

| Product ID | Pack | Qty(PCS) |
|------------|------|----------|
| KBL610G    | KBL  | 500      |

## Maximum Ratings (Ta=25°C unless otherwise noted)

| Parameter   | Symbol           | KBL610G      | Unit               |
|---|------------------|--------------|--------------------|
| Maximum repetitive peak reverse voltage   | VRRM             | 1000         | V                  |
| Maximum RMS bridge input voltage  | VRMS             | 700          | V                  |
| Maximum DC blocking voltage   | VDC              | 1000         | V                  |
| Maximum average forward rectified output current at TA=50°C                           | IF(AV)           | 6.0          | A                  |
| Peak forward surge current single sine-wave superimposed on rated load (JEDEC Method) | IFSM             | 200          | A                  |
| Rating for fusing ( t<8.3ms)  | I <sup>2</sup> t | 166          | A <sup>2</sup> sec |
| Typical thermal resistance per element (1)  | ReJA             | 10.0         | °C / W             |
| Operating junction and storage temperature range                                      | TJ,<br>TSTG      | -55 to + 150 | °C                 |

## Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified. Resistive or Inductive load,60Hz.  
For Capacitive load derate by 20 %.

| Parameter   | Symbol | KBL610G    | Unit |
|---|--------|------------|------|
| Maximum instantaneous forward voltage drop per leg at 6.0A                                | VF     | 1.1        | V    |
| Maximum DC reverse current at rated TA =25°C<br>DC blocking voltage per element TA =125°C | IR     | 10<br>1000 | μA   |

**Notes:** (1)Thermal resistance from Junction to Ambient on P.C.board mounting.



## Rating and Characteristic Curves (TA=25°C Unless otherwise noted)

Fig. 1 Derating Curve for Output Rectified Current

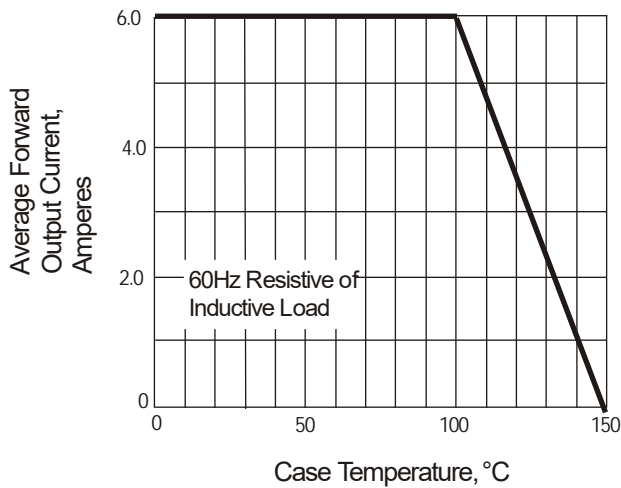


Fig. 2 Maximum Non-repetitive Peak Forward Surge Current

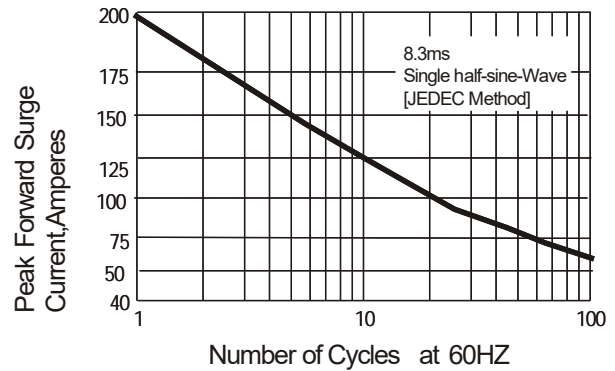


Fig. 3 Typical Instantaneous Forward Characteristics

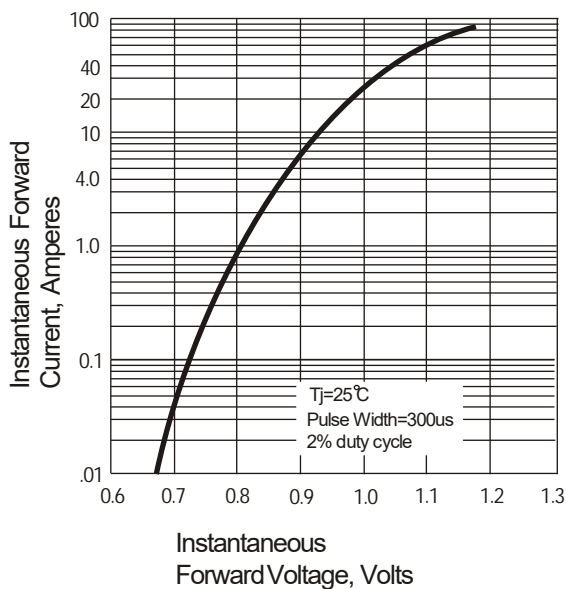


Fig. 4 Typical Reverse Characteristics

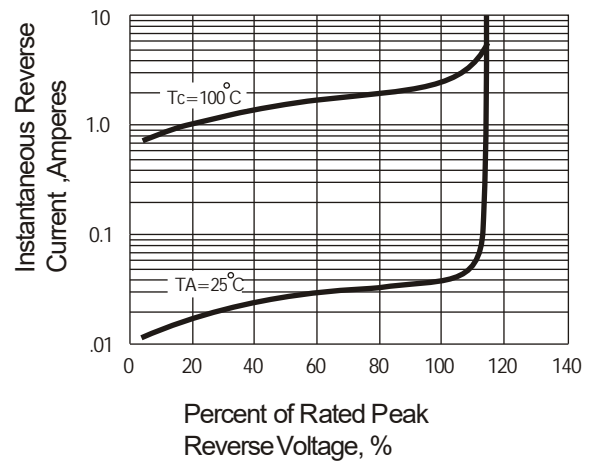
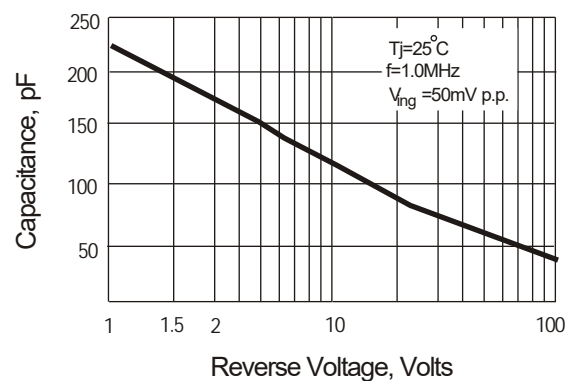
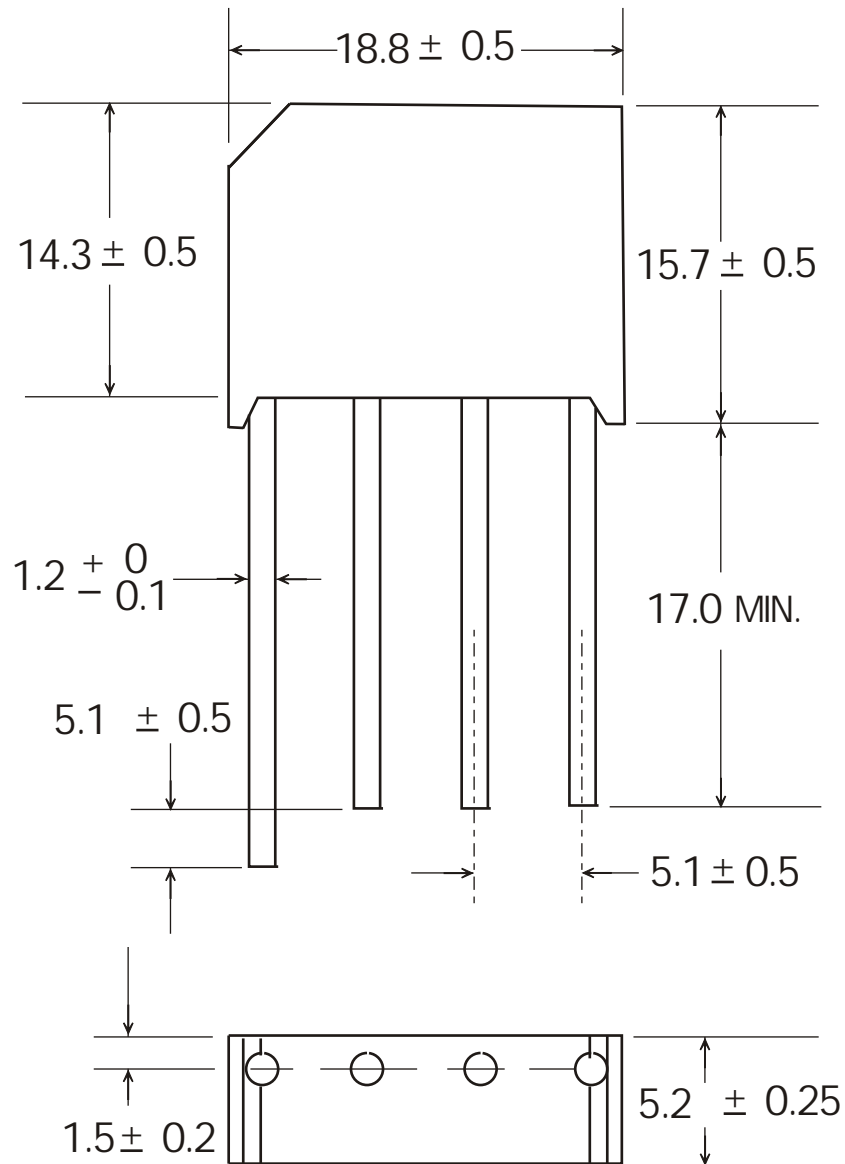


Fig. 5 Typical Junction Capacitance





### KBL Package Outline Dimensions





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